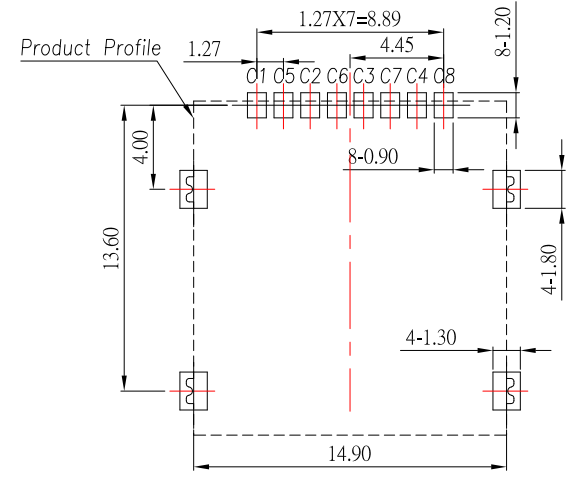
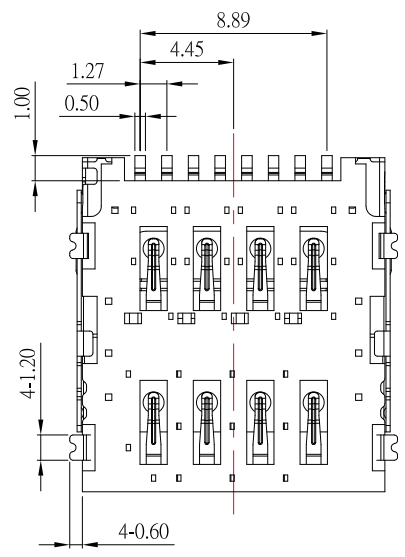
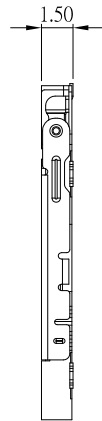
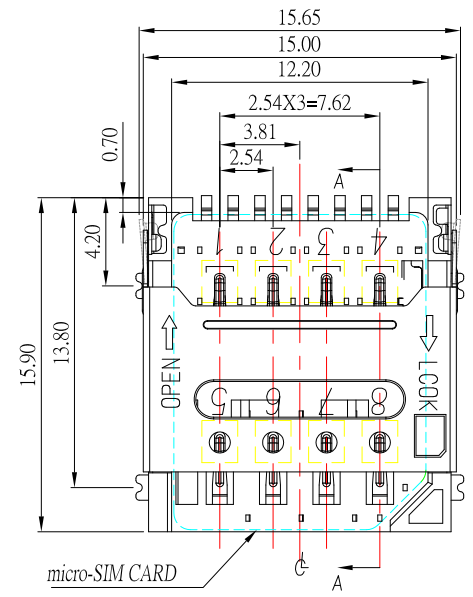
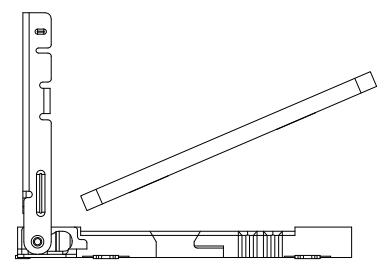
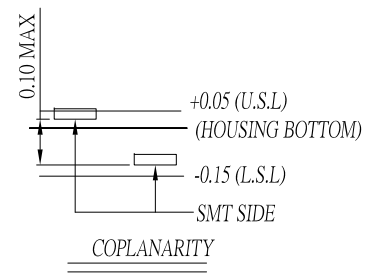
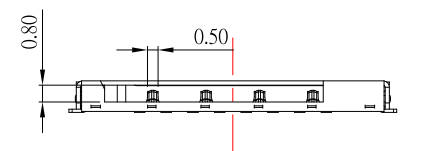


SECTION: A-A

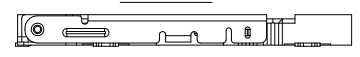


PCB LAYOYT

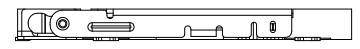
SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C4	RESERVED
C5	GND
C6	VPP
C7	I/O
C8	RESERVED



STEP 1 INSERT Micro-SIM CARD



STEP 2 PUSH THE SHELL



STEP 3 FINISH

SPECIFICATION

Electrical :

- 1.Contact Resistance: 60 mΩ Max.
- 2.Insulation Resistance: 1,000 MΩ Min.
- 3.Dielectrec Withstanding Voltage: 500 V AC

Material:

- 1.Housing: Thermoplastic
- 2.Contact: Phosphor Bronze
- 3.Shell: SUS

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface laye

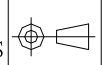


东莞市高迪电子有限公司
Dong Guan KDRR Electronic Switch Jack Co., Ltd.

TOLERANCE UNLESS OTHERWISE STATED :

Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3

3RD. ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
DATE: 03/22/18
CHECKED BY: Jacky Chen
DATE: 03/22/18
APPROVED BY: Tony Kao
DATE: 03/22/18

MAT'L
FINISH
SCALE: 1 : 1
SHEET NO. 1 of 1

TITLE: CONNECTOR
MODLE: MICRO SIM 8PIN H1.5 掀蓋
DWG NO. MSIM-08H150-S267
PART NO. MSIM-08H150-S267

SIZE: A4
VER: A0

ITEM NO.	DESCRIPTION	DRAWN	DATE
1	更新尺寸及更新為A0版	Jack	032218